

# CD4067B, CD4097B Types

## CMOS Analog Multiplexers/Demultiplexers

High-Voltage Types (20-Volt Rating)

CD4067B - Single 16-Channel Multiplexer/Demultiplexer

CD4097B - Differential 8-Channel Multiplexer/Demultiplexer

**CD4067B and CD4097B CMOS**

analog multiplexers/demultiplexers\* are digitally controlled analog switches having low ON impedance, low OFF leakage current, and internal address decoding. In addition, the ON resistance is relatively constant over the full input-signal range.

The CD4067B is a 16-channel multiplexer with four binary control inputs, A,B,C,D, and an inhibit input, arranged so that any combination of the inputs selects one switch.

The CD4097B is a differential 8-channel multiplexer having three binary control inputs A, B, C, and an inhibit input. The inputs permit selection of one of eight pairs of switches.

A logic "1" present at the inhibit input turns all channels off.

The CD4067B and CD4097B types are supplied in 24-lead hermetic dual-in-line ceramic packages (F3A suffix), 24-lead dual-in-line plastic packages (E suffix), 24-lead small-outline packages (M, M96, and NSR suffixes), and 24-lead thin shrink small-outline packages (P and PWR suffixes).

\*When these devices are used as demultiplexers, the channel in/out terminals are the outputs and the common out/in terminals are the inputs.

**Recommended Operating Conditions at T<sub>A</sub> = 25°C (Unless Otherwise Specified)**

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges. Values shown apply to all types except as noted.

Characteristic	Min.	Max.	Units
Supply-Voltage Range (T <sub>A</sub> =Full Package-Temp. Range)	3	18	V
Multiplexer Switch Input Current Capability	-	25	mA
Output Load Resistance	100	-	Ω

**NOTE:**

In certain applications, the external load-resistor current may include both V<sub>DD</sub> and signal-line components. To avoid drawing V<sub>DD</sub> current when switch current flows into the transmission gate inputs, the voltage drop across the bidirectional switch must not exceed 0.8 volt (calculated from R<sub>ON</sub> values shown in ELECTRICAL CHARACTERISTICS CHART). No V<sub>DD</sub> current will flow through R<sub>L</sub> if the switch current flows into terminal 1 on the CD4067; terminals 1 and 17 on the CD4097.

**Features:**

- Low ON resistance: 125 Ω (typ.) over 15 V<sub>pp</sub> signal-input range for V<sub>DD</sub>-V<sub>SS</sub>=15 V
- High OFF resistance: channel leakage of ±10 pA (typ.) @ V<sub>DD</sub>-V<sub>SS</sub>=10 V
- Matched switch characteristics: R<sub>ON</sub>=5 Ω (typ.) for V<sub>DD</sub>-V<sub>SS</sub>=15 V
- Very low quiescent power dissipation under all digital-control input and supply conditions: 0.2 μW (typ.) @ V<sub>DD</sub>-V<sub>SS</sub>=10 V
- Binary address decoding on chip
- 5-V, 10-V, and 15-V parametric ratings
- 100% tested for quiescent current at 20 V
- Standardized symmetrical output characteristics
- Maximum input current of 1 μA at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

**Applications:**

- Analog and digital multiplexing and demultiplexing
- A/D and D/A conversion
- Signal gating

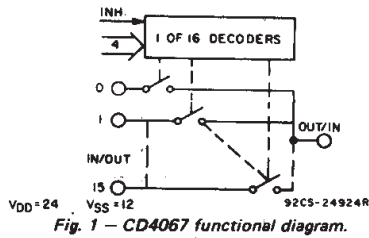
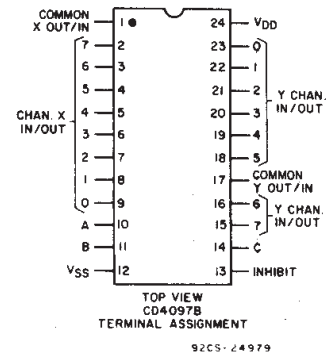
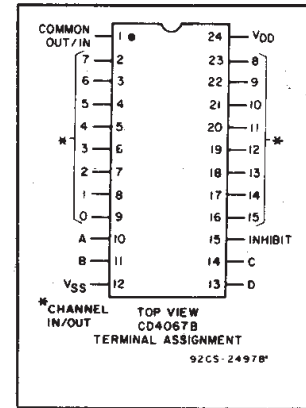


Fig. 1 - CD4067 functional diagram.

**CD4067 TRUTH TABLE**

A	B	C	D	Inh	Selected Channel
X	X	X	X	1	None
0	0	0	0	0	0
1	0	0	0	0	1
0	1	0	0	0	2
1	1	0	0	0	3
0	0	1	0	0	4
1	0	1	0	0	5
0	1	1	0	0	6
1	1	1	0	0	7
0	0	0	1	0	8
1	0	0	1	0	9
0	1	0	1	0	10
1	1	0	1	0	11
0	0	1	1	0	12
1	0	1	1	0	13
0	1	1	1	0	14
1	1	1	1	0	15

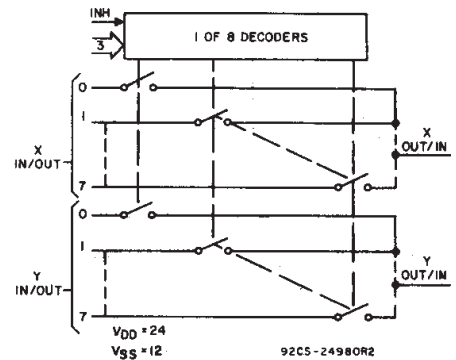


Fig. 2 - CD4097 functional diagram.

**CD4097 TRUTH TABLE**

A	B	C	Inh	Selected Channel
X	X	X	1	None
0	0	0	0	0X, 0Y
1	0	0	0	1X, 1Y
0	1	0	0	2X, 2Y
1	1	0	0	3X, 3Y
0	0	1	0	4X, 4Y
1	0	1	0	5X, 5Y
0	1	1	0	6X, 6Y
1	1	1	0	7X, 7Y

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## ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)						Units		
	$V_{is}$ (V)	$V_{SS}$ (V)	$V_{DD}$ (V)	-55	-40	+85	+125	+25				
								Min.	Typ.		Max.	
<b>SIGNAL INPUTS (<math>V_{is}</math>) AND OUTPUTS (<math>V_{OS}</math>)</b>												
Quiescent Device Current, $I_{DD}$ Max.			5	5	5	150	150	—	0.04	5	$\mu A$	
			10	10	10	300	300	—	0.04	10		
			15	20	20	600	600	—	0.04	20		
			20	100	100	3000	3000	—	0.08	100		
ON-state Resistance $V_{SS} \leq V_{is} \leq V_{DD}$ $r_{on}$ Max.		0	5	800	850	1200	1300	—	470	1050	$\Omega$	
		0	10	310	330	520	550	—	180	400		
		0	15	200	210	300	320	—	125	240		
Change in on-state Resistance (Between Any Two Channels) $\Delta r_{on}$		0	5	—	—	—	—	—	15	—	$\Omega$	
		0	10	—	—	—	—	—	10	—		
		0	15	—	—	—	—	—	5	—		
OFF Channel Leakage Current: Any Channel OFF (Common OUT/IN) Max. or All Channels OFF		0	18	$\pm 100^*$	$\pm 1000^*$	—	—	—	$\pm 0.1$	$\pm 100^*$	$nA$	
Capacitance: Input, $C_{is}$				—	—	—	—	—	5	—	$pF$	
Output, $C_{os}$				—	—	—	—	—	55	—		
CD4067 CD4097		-5	5	—	—	—	—	—	35	—		
Feed-through, $C_{ios}$				—	—	—	—	—	0.2	—		
	Propagation Delay Time (Signal Input to Output)	$V_{DD}$ 	$R_L = 200 K\Omega$	5	—	—	—	—	—	30	60	$ns$
			$C_L = 50 pF$	10	—	—	—	—	—	15	30	
$t_r, t_f = 20 ns$			15	—	—	—	—	—	10	20		
<b>CONTROL (ADDRESS or INHIBIT) <math>V_C</math></b>												
Input Low Voltage, $V_{IL}$ Max.	$=V_{DD}$ thru $1 K\Omega$	$R_L = 1 K\Omega$ to $V_{SS}$ $I_{IS} < 2 \mu A$ on all OFF Channels	5	1.5	—	—	—	—	—	1.5	$V$	
			10	3	—	—	—	—	3			
			15	4	—	—	—	—	4			
Input High Voltage, $V_{IH}$ Min.	$1 K\Omega$	$R_L = 1 K\Omega$ to $V_{SS}$ $I_{IS} < 2 \mu A$ on all OFF Channels	5	3.5	3.5	—	—	—	—	—		
			10	7	7	—	—	—	—			
			15	11	11	—	—	—	—			

\* Determined by minimum feasible leakage measurement for automatic testing.

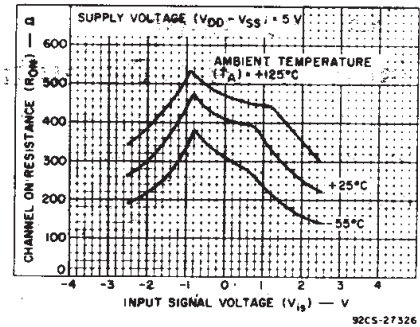


Fig. 3—Typical ON resistance vs. input signal voltage (all types).

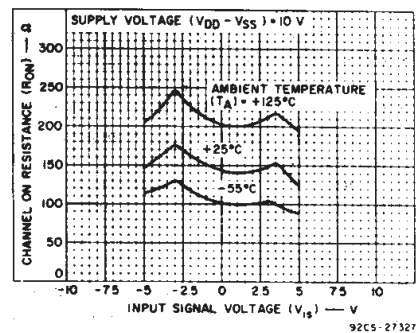


Fig. 4—Typical ON resistance vs. input signal voltage (all types).

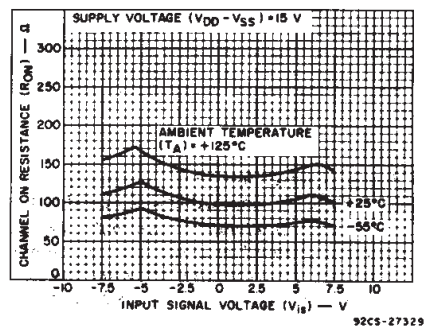


Fig. 5—Typical ON resistance vs. input signal voltage (all types).

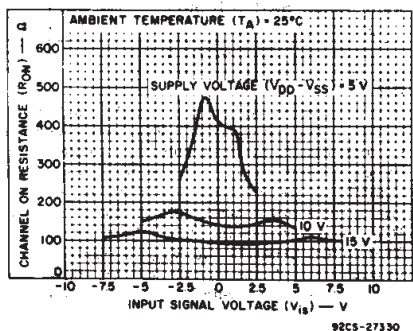


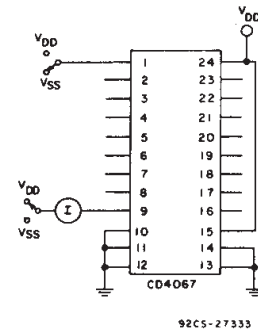
Fig. 6—Typical ON resistance vs. input signal voltage (all types).

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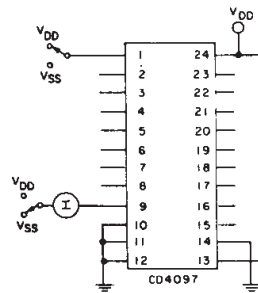
## ELECTRICAL CHARACTERISTICS (Cont'd)

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)						Units	
	V <sub>is</sub> (V)	V <sub>SS</sub> (V)	V <sub>DD</sub> (V)	-55	-40	+85	+125	+25			
								Min.	Typ.		Max.
Input Current, I <sub>IN</sub> Max.	V <sub>IN</sub> = 0, 18 V			±0.1	±0.1	±1	±1	—	±10 <sup>-5</sup>	±0.1	μA
Propagation Delay Time: Address or Inhibit-to-Signal OUT (Channel turning ON)	R <sub>L</sub> = 10 KΩ, C <sub>L</sub> = 50 pF, t <sub>r</sub> , t <sub>f</sub> = 20 ns			—	—	—	—	—	325	650	ns
	0	5	—	—	—	—	—	—	135	270	
	0	10	—	—	—	—	—	—	95	190	
Address or Inhibit-to-Signal OUT (Channel turning OFF)	R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 50 pF, t <sub>r</sub> , t <sub>f</sub> = 20 ns			—	—	—	—	—	220	440	ns
	0	5	—	—	—	—	—	—	90	180	
	0	15	—	—	—	—	—	—	65	130	
Input Capacitance, C <sub>IN</sub>	Any Address or Inhibit Input			—	—	—	—	—	5	7.5	pF

## TEST CIRCUITS



92CS-27333

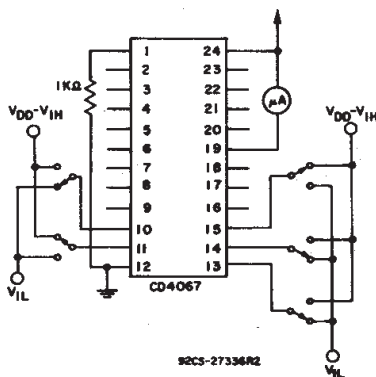


92CS-27332

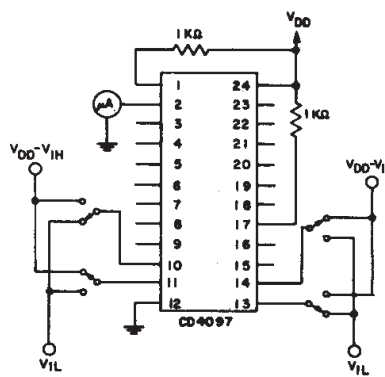
Fig. 7—OFF channel leakage current—any channel OFF.

## MAXIMUM RATINGS, Absolute-Maximum Values:

- DC SUPPLY-VOLTAGE RANGE, (V<sub>DD</sub>)  
Voltages referenced to V<sub>SS</sub> Terminal) ..... -0.5V to +20V
- INPUT VOLTAGE RANGE, ALL INPUTS ..... -0.5V to V<sub>DD</sub> +0.5V
- DC INPUT CURRENT, ANY ONE INPUT ..... ±10mA
- POWER DISSIPATION PER PACKAGE (P<sub>D</sub>):  
For T<sub>A</sub> = -55°C to +100°C ..... 500mW  
For T<sub>A</sub> = +100°C to +125°C ..... Derate Linearly at 12mW/°C to 200mW
- DEVICE DISSIPATION PER OUTPUT TRANSISTOR  
FOR T<sub>A</sub> = FULL PACKAGE-TEMPERATURE RANGE (All Package Types) ..... 100mW
- OPERATING-TEMPERATURE RANGE (T<sub>A</sub>) ..... -55°C to +125°C
- STORAGE TEMPERATURE RANGE (T<sub>stg</sub>) ..... -65°C to +150°C
- LEAD TEMPERATURE (DURING SOLDERING):  
At distance 1/16 ± 1/32 inch (1.59 ± 0.79mm) from case for 10s max ..... +265°C

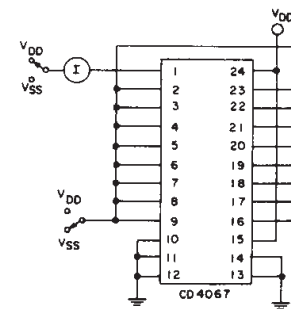


92CS-27336R2

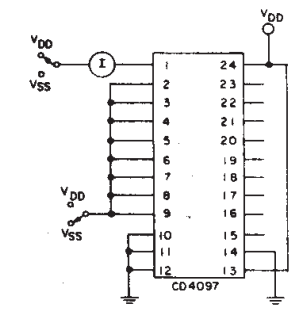


92CS-27337R2

Fig. 8—Input voltage—measure < 2 μA on all OFF channels (e.g., channel 12).



92CS-27334



92CS-27335

Fig. 9—OFF channel leakage current—all channels OFF.

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## ELECTRICAL CHARACTERISTICS (Cont'd)

CHARACTERISTIC	TEST CONDITIONS			TYPICAL VALUES	UNITS			
	V <sub>is</sub> (V)	V <sub>DD</sub> (V)	R <sub>L</sub> (KΩ)					
Cutoff (-3 dB) Frequency Channel ON (Sine Wave Input)	5 <sup>●</sup>	10	1	CD4067	14	MHz		
	20 log $\frac{V_{os}}{V_{is}} = -3$ dB			CD4097	20			
Total Harmonic Distortion, THD	f <sub>is</sub> = 1 kHz sine wave			V <sub>os</sub> at Common OUT/IN		%		
				V <sub>os</sub> at Any Channel			60	
				2 <sup>●</sup>	5		10	0.3
				3 <sup>●</sup>	10			0.2
5 <sup>●</sup>	15	0.12						
-40 dB Feedthrough Frequency (All Channels OFF)	5 <sup>●</sup>	10	1	CD4067	20	MHz		
	20 log $\frac{V_{os}}{V_{is}} = -40$ dB			CD4097	12			
Signal Crosstalk (Frequency at -40 dB)	5 <sup>●</sup>	10	1	Between Any 2 Channels <sup>▲</sup>		1	MHz	
	20 log $\frac{V_{os}}{V_{is}} = -40$ dB			Between Sections CD4097 Only	Measured on Common	10		
					Measured on Any Channel	18		
Address-or-Inhibit-to-Signal Crosstalk	V <sub>SS</sub> =0, t <sub>r</sub> , t <sub>f</sub> =20 ns, V <sub>C</sub> =V <sub>DD</sub> -V <sub>SS</sub> (Square Wave)					75	mV (Peak)	

● Peak-to-peak voltage symmetrical about  $\frac{V_{DD}-V_{SS}}{2}$ .

▲ Worst case.

\* Both ends of channel.

## TEST CIRCUITS (Cont'd)

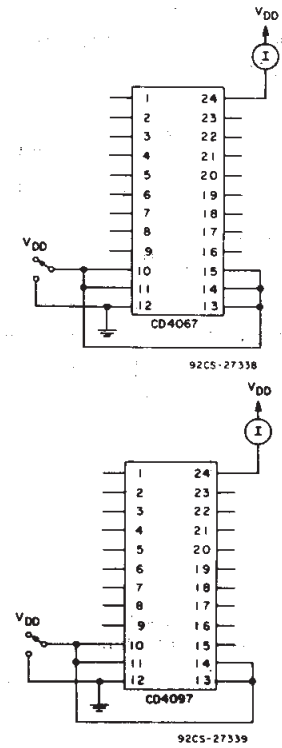


Fig. 10—Quiescent device current.

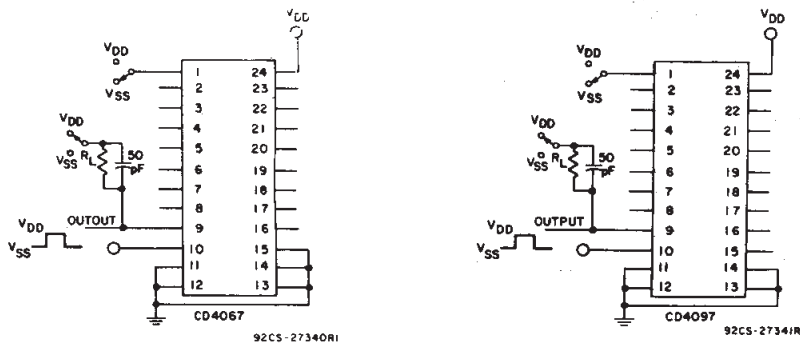


Fig. 11—Turn-on and turn-off propagation delay—address select input to signal output (e.g. measured on channel 0).

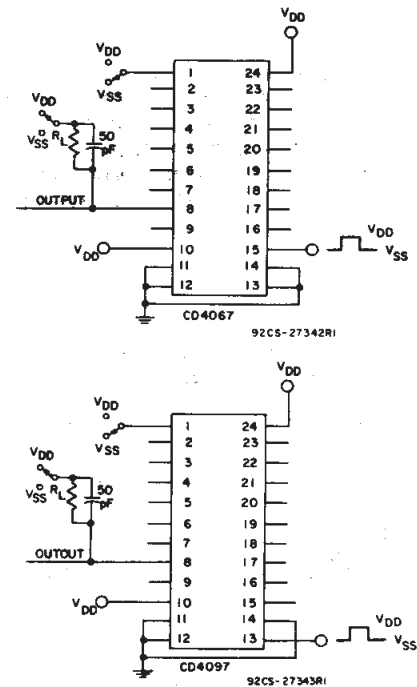


Fig. 12—Turn-on and turn-off propagation delay—  
inhibit input to signal output (e.g. measured on channel 1).

# CD4067B, CD4097B Types

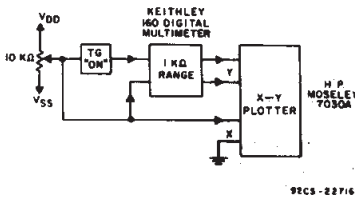


Fig. 13- Channel ON resistance measurement circuit.

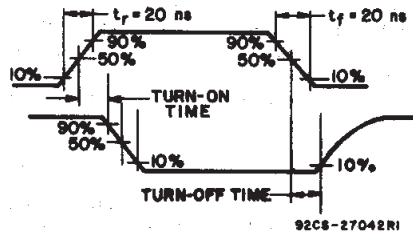


Fig. 14- Propagation delay waveform channel being turned ON ( $R_L = 10\text{ K}\Omega$ ,  $C_L = 50\text{ pF}$ ).

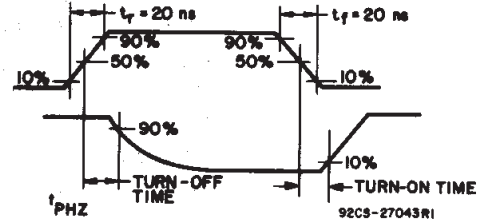


Fig. 15- Propagation delay waveform, channel being turned OFF ( $R_L = 300\Omega$ ,  $C_L = 50\text{ pF}$ ).

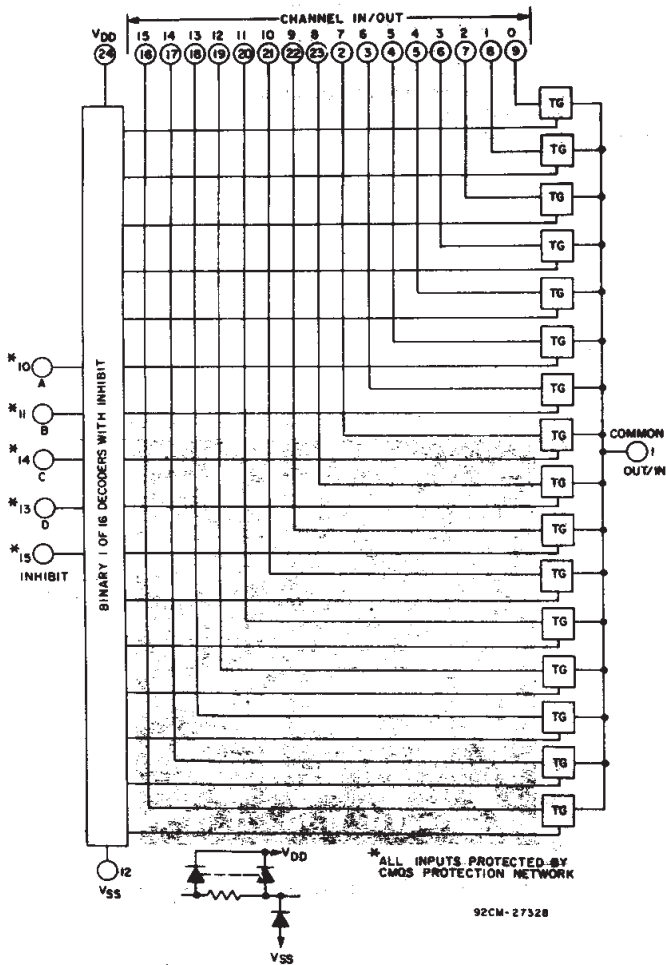


Fig. 16- CD4067 logic diagram.

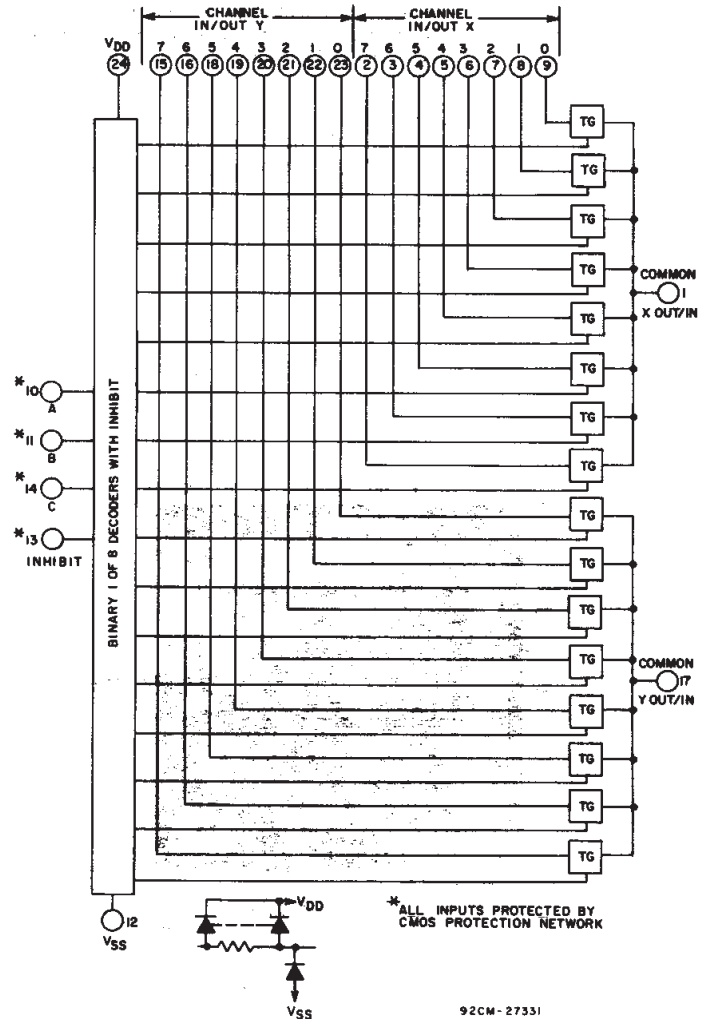


Fig. 17- CD4097 logic diagram.

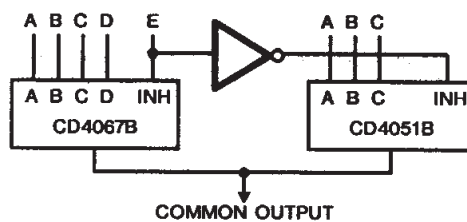


Fig. 18-24-to-1 MUX Addressing

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### SPECIAL CONSIDERATIONS

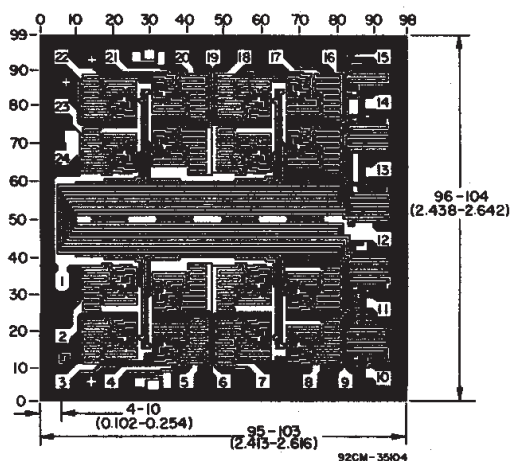
In applications where separate power sources are used to drive  $V_{DD}$  and the signal inputs, the  $V_{DD}$  current capability should exceed  $V_{DD}/R_L$  ( $R_L$ =effective external load). This provision avoids permanent current flow or clamp action on the  $V_{DD}$  supply when power is applied or removed from the CD4067B or CD4097B.

When switching from one address to another, some of the ON periods of the channels of the multiplexers will overlap momentarily, which may be objectionable in certain applications. Also when a channel is turned on or off by an address input, there is a momentary conductive path from the channel to  $V_{SS}$ , which will dump some charge from any capacitor connected to the input or output of the channel. The inhibit input turning on a channel will similarly dump some charge to  $V_{SS}$ .

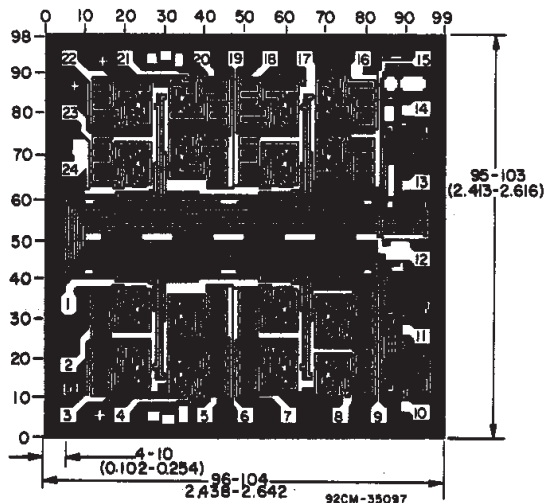
The amount of charge dumped is mostly a function of the signal level above  $V_{SS}$ . Typically, at  $V_{DD}-V_{SS}=10$  V, a 100-pF

capacitor connected to the input or output of the channel will lose 3-4% of its voltage at the moment the channel turns on or off. This loss of voltage is essentially independent of the address or inhibit signal transition time, if the transition time is less than 1-2  $\mu$ s. When the inhibit signal turns a channel off, there is no charge dumping to  $V_{SS}$ . Rather, there is a slight rise in the channel voltage level (65 mV typ.) due to capacitive coupling from inhibit input to channel input or output. Address inputs also couple some voltage steps onto the channel signal levels.

In certain applications, the external load-resistor current may include both  $V_{DD}$  and signal-line components. To avoid drawing  $V_{DD}$  current when switch current flows into the transmission gate inputs, the voltage drop across the bidirectional switch must not exceed 0.8 volt (calculated from  $R_{ON}$  values shown in ELECTRICAL CHARACTERISTICS CHART). No  $V_{DD}$  current will flow through  $R_L$  if the switch current flows into terminal 1 on the CD4067B, terminals 1 and 17 on the CD4097B.



Dimensions and pad layout for CD4067BH.



Dimensions and pad layout for CD4097BH.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils ( $10^{-3}$  inch).

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
CD4067BE	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4067BF	ACTIVE	CDIP	J	24	1	TBD	Call TI	Level-NC-NC-NC
CD4067BF3A	ACTIVE	CDIP	J	24	1	TBD	Call TI	Level-NC-NC-NC
CD4067BM	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4067BM96	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4067BM96E4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4067BME4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4067BNSR	ACTIVE	SO	NS	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4067BNSRE4	ACTIVE	SO	NS	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4067BPW	ACTIVE	TSSOP	PW	24	60	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4067BPWE4	ACTIVE	TSSOP	PW	24	60	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4067BPWR	ACTIVE	TSSOP	PW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4067BPWRE4	ACTIVE	TSSOP	PW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4097BE	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4097BF	ACTIVE	CDIP	J	24	1	TBD	Call TI	Level-NC-NC-NC
CD4097BM	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4097BM96	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4097BM96E4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4097BME4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4097BNSR	ACTIVE	SO	NS	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4097BNSRE4	ACTIVE	SO	NS	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4097BPW	ACTIVE	TSSOP	PW	24	60	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4097BPWE4	ACTIVE	TSSOP	PW	24	60	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4097BPWR	ACTIVE	TSSOP	PW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4097BPWRE4	ACTIVE	TSSOP	PW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

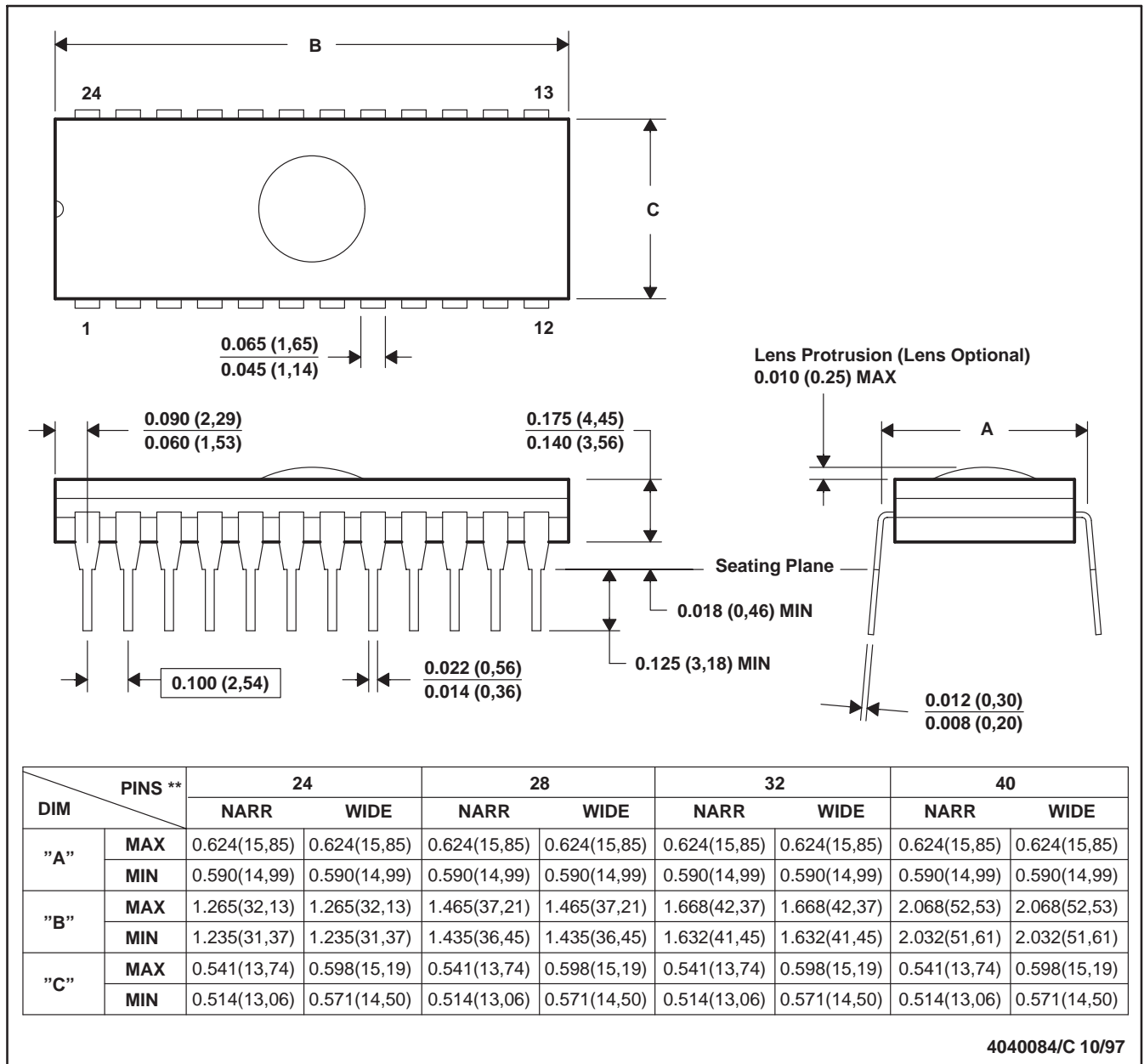
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J (R-GDIP-T\*\*)

CERAMIC DUAL-IN-LINE PACKAGE

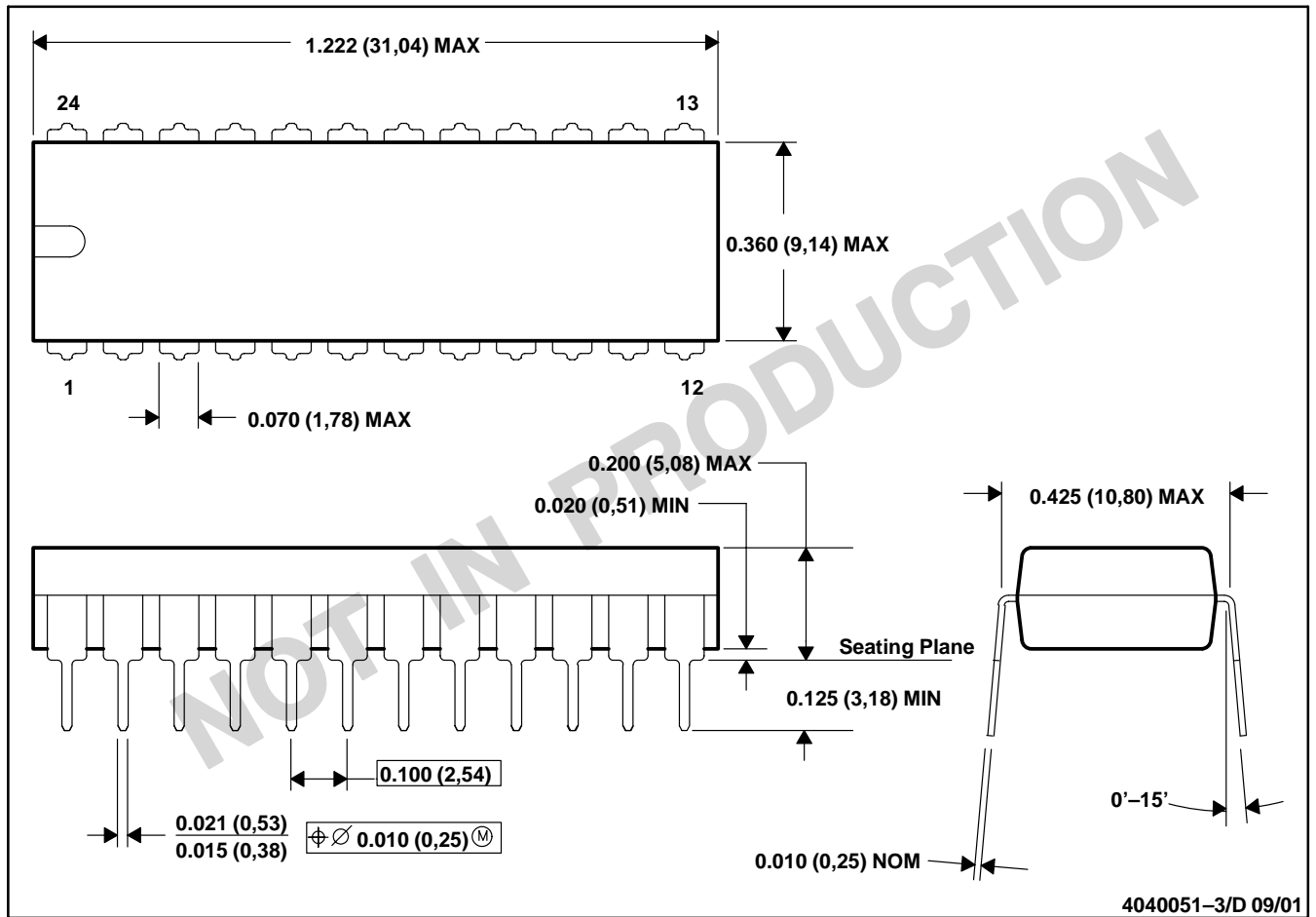
24 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Window (lens) added to this group of packages (24-, 28-, 32-, 40-pin).  
 D. This package can be hermetically sealed with a ceramic lid using glass frit.  
 E. Index point is provided on cap for terminal identification.

N (R-PDIP-T24)

PLASTIC DUAL-IN-LINE

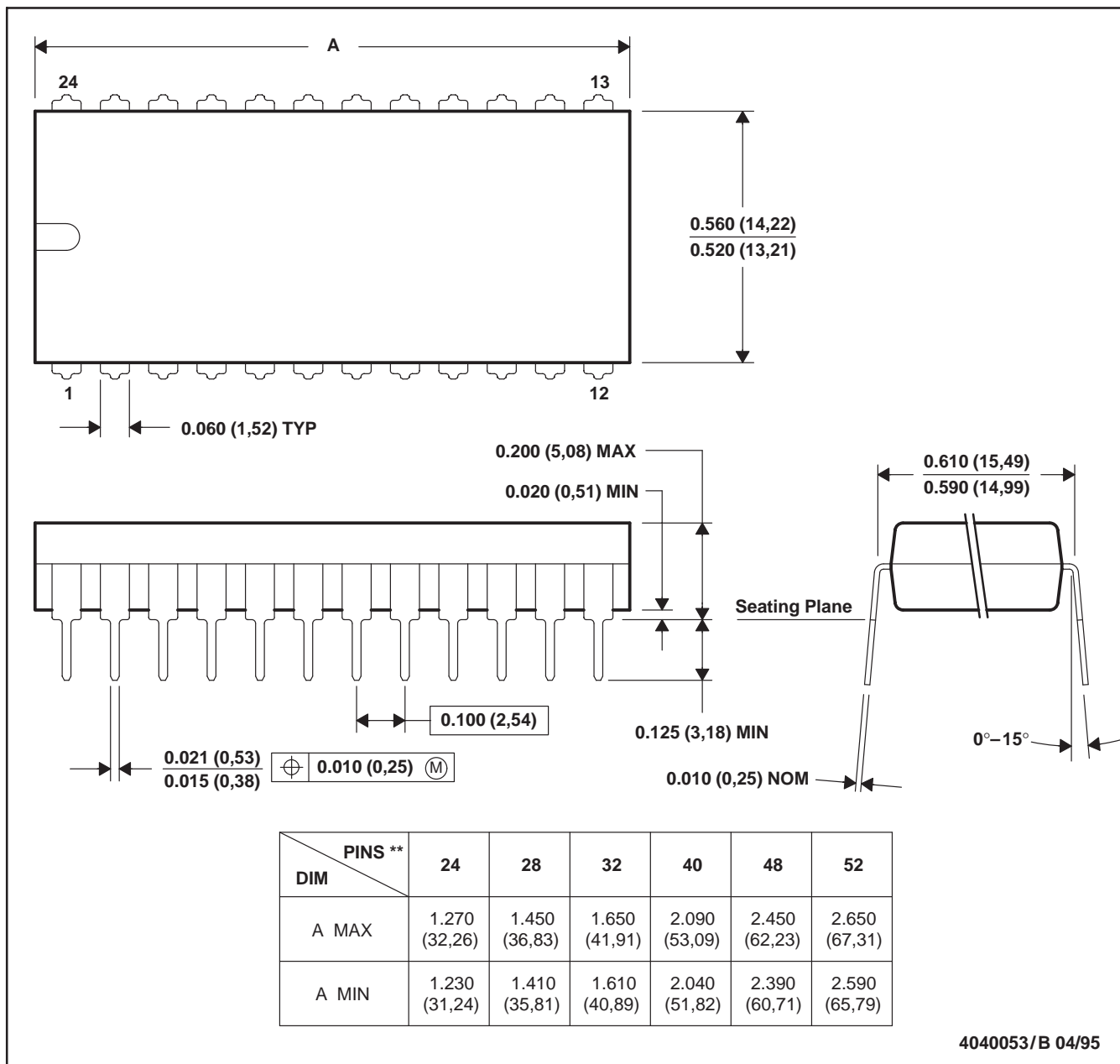


- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-010

**N (R-PDIP-T\*\*)**

**PLASTIC DUAL-IN-LINE PACKAGE**

24 PIN SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-011  
 D. Falls within JEDEC MS-015 (32 pin only)



## MECHANICAL DATA

**NS (R-PDSO-G\*\*)**

**PLASTIC SMALL-OUTLINE PACKAGE**

**14-PINS SHOWN**



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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